



#### P-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> T <sub>A</sub> = +25°C
-20V	78mΩ @ V <sub>GS</sub> = -8V	-3.4A
	100mΩ @ V <sub>GS</sub> = -4.5V	-3.0A

#### **Description**

This new generation MOSFET is designed to minimize the footprint in handheld and mobile application. It can be used to replace many small signals MOSFET with as really small footprint.

## **Applications**

- Battery Management
- Load Switch
- Battery Protection
- · Handheld and Mobile Application

# ESD PROTECTED TO 4KV

## **Features and Benefits**

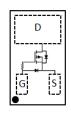
- Low Qg & Qgd
- Small Footprint
- Low Profile 0.20mm Height
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

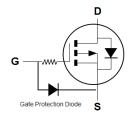
## **Mechanical Data**

- Case: X4-DSN1006-3
- Terminal Connections: See Diagram Below
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.00029 grams (Approximate)





Top View



**Equivalent Circuit** 

## Ordering Information (Note 4)

I	Part Number	Case	Packaging
I	DMP2078LCA3-7	X4-DSN1006-3	10k/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



O = Product Type Marking Code YW = Date Code Marking Y or  $\overline{Y}$  = Year (ex: 0 = 2020) W or  $\overline{W}$  = Week (ex: a =week 27; z represents week 52 and 53)

#### Date Code Key

Year	2017		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	7		0	1	2	3	4	5	6	7	8	9
Week	Week 1-26					27-52			53			
WCCK	1-20					-J <u>L</u>						
Code		A	\-Z		a-z						Z	



### **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DSS</sub>	-20	V		
Gate-Source Voltage	Vgss	-12	V		
Continuous Drain Current (Note 5) V <sub>GS</sub> = -8V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	lo	-3.4 -2.7	А
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	I <sub>D</sub>	-3.0 -2.4	А		
Pulsed Drain Current (Note 6)	I <sub>DM</sub>	-13	Α		
Human Body Model (HBM)	$V_{(ESD)}$	4	kV		

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	PD	0.81	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 7)	$R_{\theta JA}$	155.4	°C/W
Power Dissipation (Note 5)	PD	1.4	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 5)	$R_{\theta JA}$	90.4	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

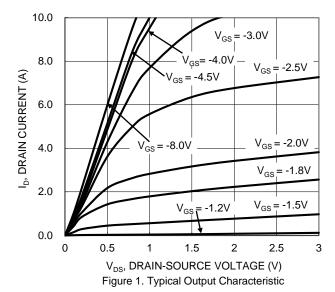
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

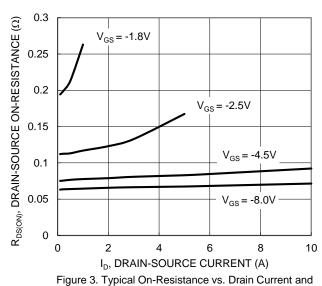
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 8)								
Drain-Source Breakdown Voltage	BVDSS	-20	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$		
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	IDSS	_	_	-100	nA	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V		
Gate-Source Leakage	Igss	_	_	-50	nA	Vgs = -12V, Vps = 0V		
ON CHARACTERISTICS (Note 8)								
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.7	-0.9	-1.2	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$		
		1	64	78		$V_{GS} = -8V, I_{D} = -0.5A$		
Static Drain-Source On-Resistance	Dragos.		77	100	mΩ	$V_{GS} = -4.5V, I_{D} = -0.5A$		
Static Dialit-Source Off-Resistance	RDS(ON)	_	113	165	11122	$V_{GS} = -2.5V, I_D = -0.5A$		
		_	188	600		$V_{GS} = -1.8V, I_D = -0.1A$		
Diode Forward Voltage	VsD	_	-0.7	-1.0	V	$V_{GS} = 0V, I_{S} = -0.5A$		
Reverse Recovery Charge	Qrr	_	1.3	_	nC	V <sub>DD</sub> = -10V, I <sub>F</sub> = -1A,		
Reverse Recovery Time	t <sub>RR</sub>		7.7		ns	di/dt = 100A/µs		
DYNAMIC CHARACTERISTICS (Note 9)								
Input Capacitance	Ciss	_	152	228		V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V, f = 1MHz		
Output Capacitance	Coss	_	78	117	pF			
Reverse Transfer Capacitance	C <sub>rss</sub>	_	4.3	6.4		1 = 1101112		
Series Gate Resistance	R <sub>G</sub>	_	21	31	Ω	$f = 1MHz$ , $V_{GS} = 0V$ , $V_{DS} = 0V$		
Total Gate Charge	Qg	_	1.1	1.6				
Gate-Source Charge	Qgs		0.2		nC	V <sub>G</sub> S = -4.5V, V <sub>D</sub> S = -10V,		
Gate-Drain Charge	Q <sub>gd</sub>		0.2		nc	$I_D = -0.5A$		
Gate Charge at VTH	Q <sub>g(th)</sub>		3.6					
Turn-On Delay Time	tD(ON)		4.1	6.1				
Turn-On Rise Time	t <sub>R</sub>	_	5.6			$V_{DS} = -10V, V_{GS} = -4.5V,$		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	9.5	14.2	ns	$R_G = 2\Omega$ , $I_D = -0.5A$		
Turn-Off Fall Time	tF		4.6	_				

Notes:

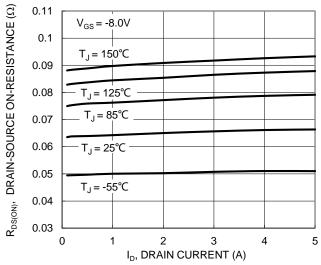
- 5. Device mounted on FR-4 material with 1inch² (6.45cm²), 2oz. (0.071mm thick) Cu.
- 6. Repetitive rating, pulse width limited by junction temperature.
- 7. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to production testing.

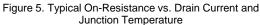






Gate Voltage





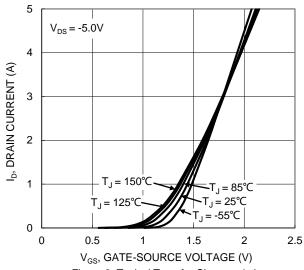


Figure 2. Typical Transfer Characteristic

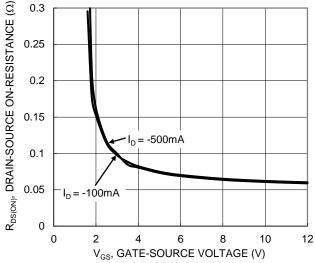


Figure 4. Typical Transfer Characteristic

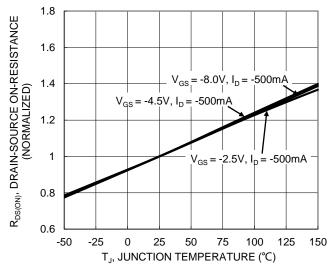


Figure 6. On-Resistance Variation with Junction Temperature



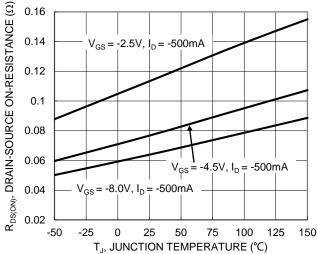


Figure 7. On-Resistance Variation with Junction Temperature

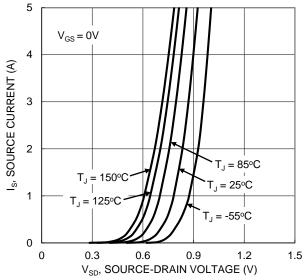


Figure 9. Diode Forward Voltage vs. Current

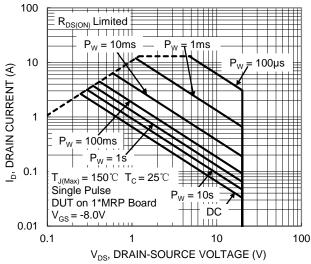
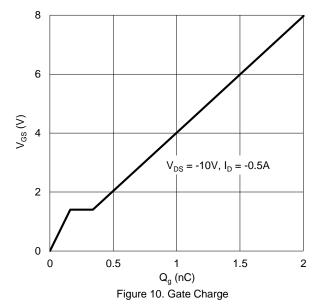


Figure 11. SOA, Safe Operation Area

 $V_{\text{GS(TH)}},$  GATE THRESHOLD VOLTAGE (V) -1mA 1  $I_{D} = -250 \mu A$ 8.0 0.6 0.4 75 125 -50 -25 25 50 100 150

1.2

T<sub>J</sub>, JUNCTION TEMPERATURE (°C) Figure 8. Gate Threshold Variation vs. Junction Temperature





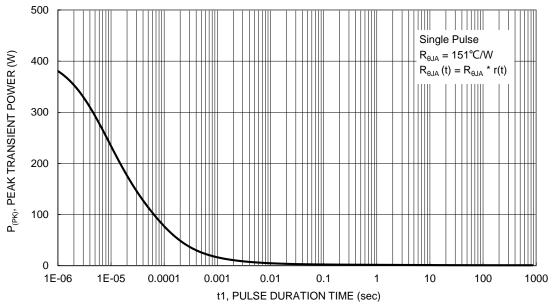


Figure 12. Single Pulse Maximum Power Dissipation

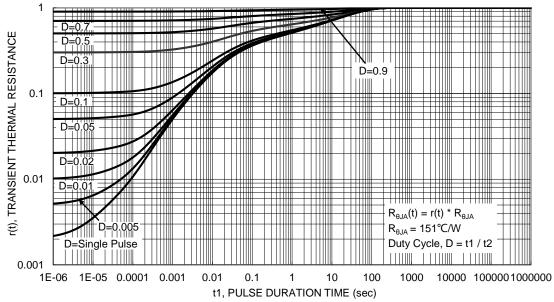
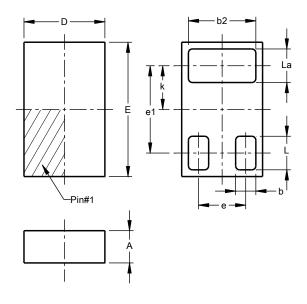


Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

#### X4-DSN1006-3

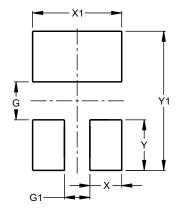


X4-DSN1006-3							
Dim	Min	Max	Тур				
Α	0.18	0.22	0.20				
b	0.14	0.16	0.15				
b2	0.49	0.51	0.50				
D	0.56	0.64	0.60				
Е	0.96	1.04	1.00				
е			0.35				
e1			0.65				
k			0.325				
L	0.24	0.26	0.25				
La	0.24	0.26	0.25				
All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X4-DSN1006-3



Dimensions	Value		
Dilliensions	(in mm)		
G	0.40		
G1	0.20		
Х	0.15		
X1	0.50		
Y	0.25		
Y1	0.90		



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